NXP

Issue Date: 16-Jul-2020
Effective Date: 17-Jul-2020

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QUALITY

Change Category

[ ] Wafer Fab Process	[ ] Assembly Process	[X] Product Marking	[ ] Test Location	[ ] Design
[ ] Wafer Fab Materials	[ ] Assembly Materials	[ ] Mechanical Specification	[ ]Test Process	[ ] Errata
[ ] Wafer Fab Location	[ ] Assembly Location	[ ] Packing/Shipping/Labeling	[ ] Test Equipment	[ ] Electrical spec./Test coverage
[ ] Firmware	[ ] Other			

Marking Format Change for MC9S12E128CFUER, MC9S08GT8ACFBE and MC9S08GT16ACFBE

Description

NXP Semiconductors announces the standardization of marking for the MC9S12E128CFUER, MC9S08GT8ACFBE and MC9S08GT16ACFBE.

Marking change are summarized in the attached file with this notification.

Reason
The marking change is to standardize marking format for the parts with tray, tape and reel packing.
Identification of Affected Products
Top side marking
Refer to attachment for detail

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.
Disposition of Old Products
Existing inventory will be shipped until depleted

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Changed Orderable Part#
MC9S08GT16ACFBE